## UNCONTROLLED DOCUMENT

## - 13.00 [0.512] —— 11.00 [0.433] P Layer -

N Layer



PART NUMBER

SSD-LX1311E470GGPU

ELECTRO-OPTICAL CHARACTERISTICS:

PARAMETER	SYMBOL	TEST COND	MIN	TYP	MAX	UNITS
FORWARD VOLTAGE	Vf	I <sub>f</sub> =20mA		3.2	3.4	٧
REVERSE CURRENT	١r	V <sub>r</sub> =5V			10	μA
PEAK WAVELENGTH	λp	I <sub>f</sub> =20mA		470		nm
SPECTRA HALF-WIDTH	Δλ	I <sub>f</sub> =20mA		30		пm
RADIANT POWER	Po	I <sub>f</sub> =20mA	1.0			mW

CAUTION: STATIC SENSITIVE DEVICE FOLLOW PROPER E.S.D. HANDLING PROCEDURES WHEN WORKING WITH THIS PART.

## NOTEs:

- 1. UNITS: mil
- 2. WIRE BOND METALLIZATION: GOLD.

## UNCONTROLLED DOCUMENT

REV. PART NUMBER SSD-LX1311E470GGPU

470nm CHIP.

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RELIABILITY NOTE

OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



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CHECKED BY: APPROVED BY: DATE: 7.17.02

PAGE: 1 OF 1 SCALE: N/A

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DRAWN BY: